



PAPARFRAME™ & BOARDFRAME™

Introduction



Products Introduction

Manufacturer & Distributor for

PAPERFRAME™ & BOARDFRAME™ **For Mold Cleaning And Dummy Molding**



PAPERFRAME™ & BOARDFRAME™

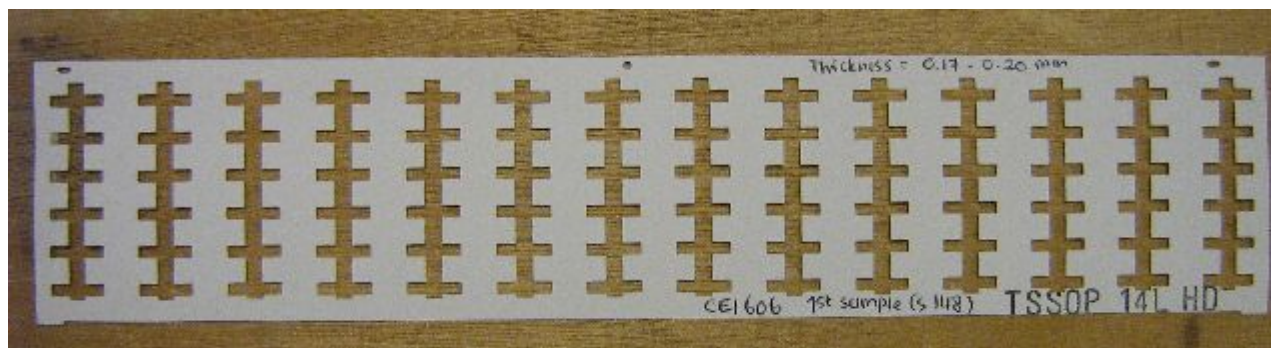
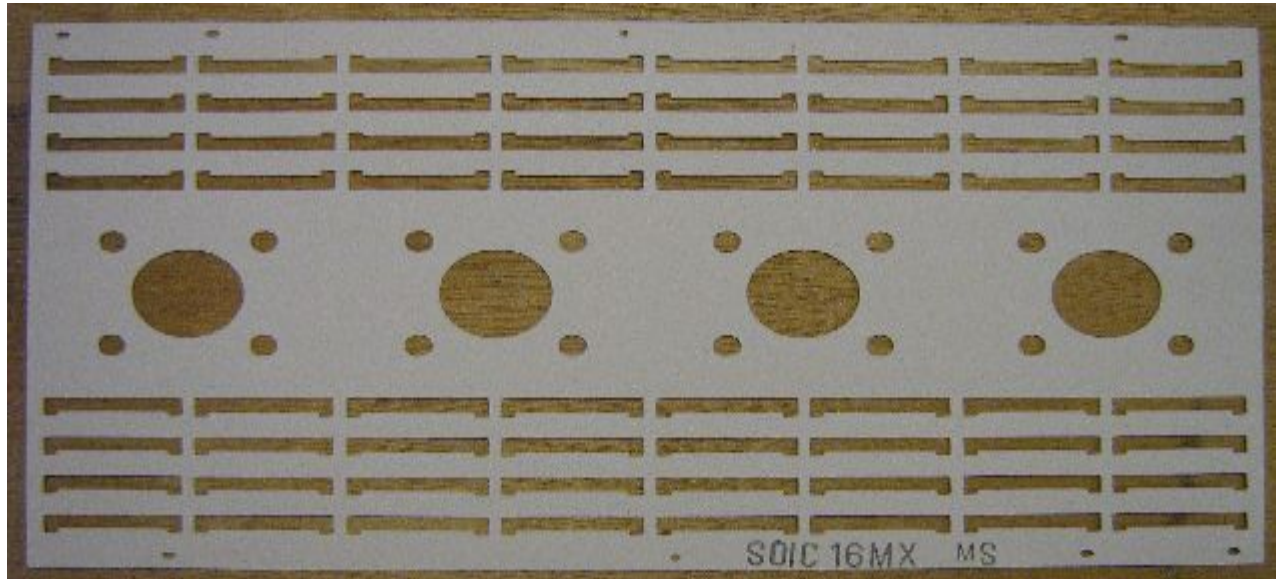
- PAPERFRAME™ / BOARDFRAME™ is a unique product specially designed to substitute conventional metal lead frames or substrate for *cost-reduction* in mold cleaning process.
- Intentionally developed for melamine cleaning in molds used in transfer encapsulating of electric and electronics components by means of epoxy molding compounds as well as dummy molding.
- Available in the form of single strip and *multiple strips*.

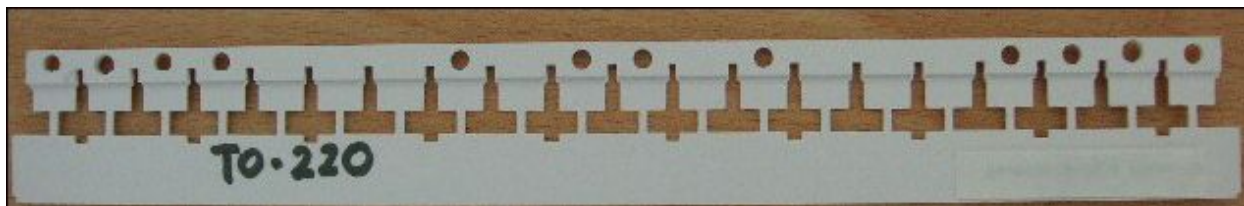
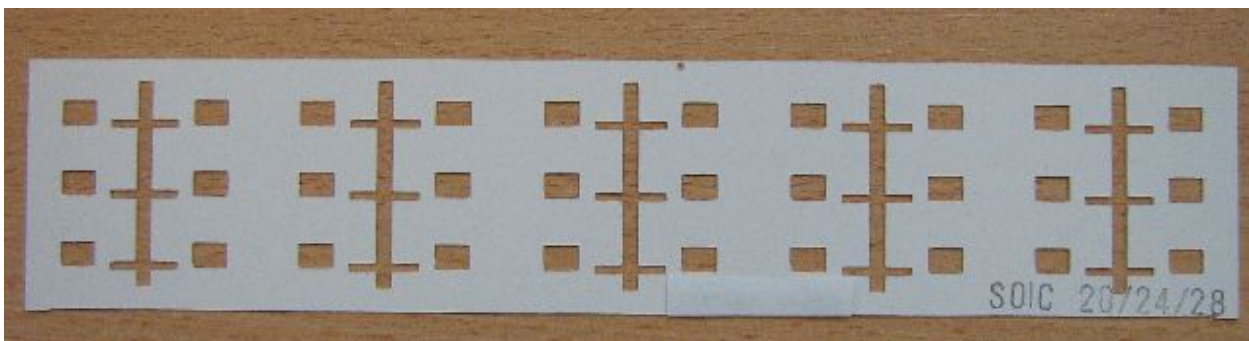
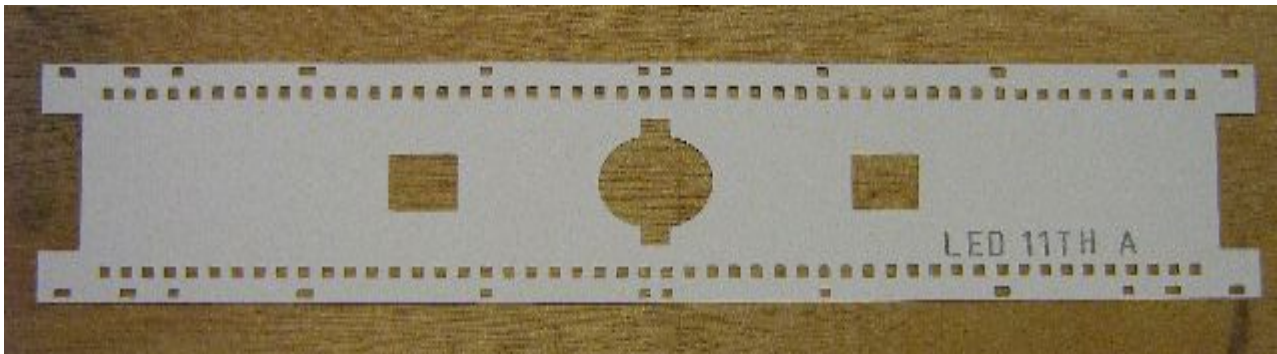
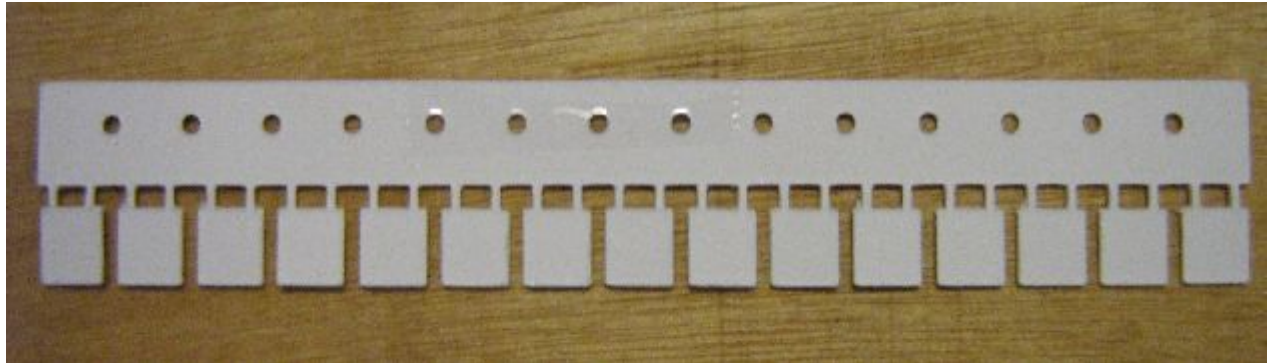
Features enhance the PAPERFRAME™ / BOARDFRAME™'s usability and capability in cleaning the mold contamination shown as below;

- No need to change molding temperature and parameters. (For auto-mold, recommended to switch to manual mode)
- **Air-vent cleaning design** increase cleaning effectiveness in hard-to-reach area.
- **Easy removal** (time saving) from mold surface particularly the multiple strips type.
- Safe to use as it is **non-corrosive**.



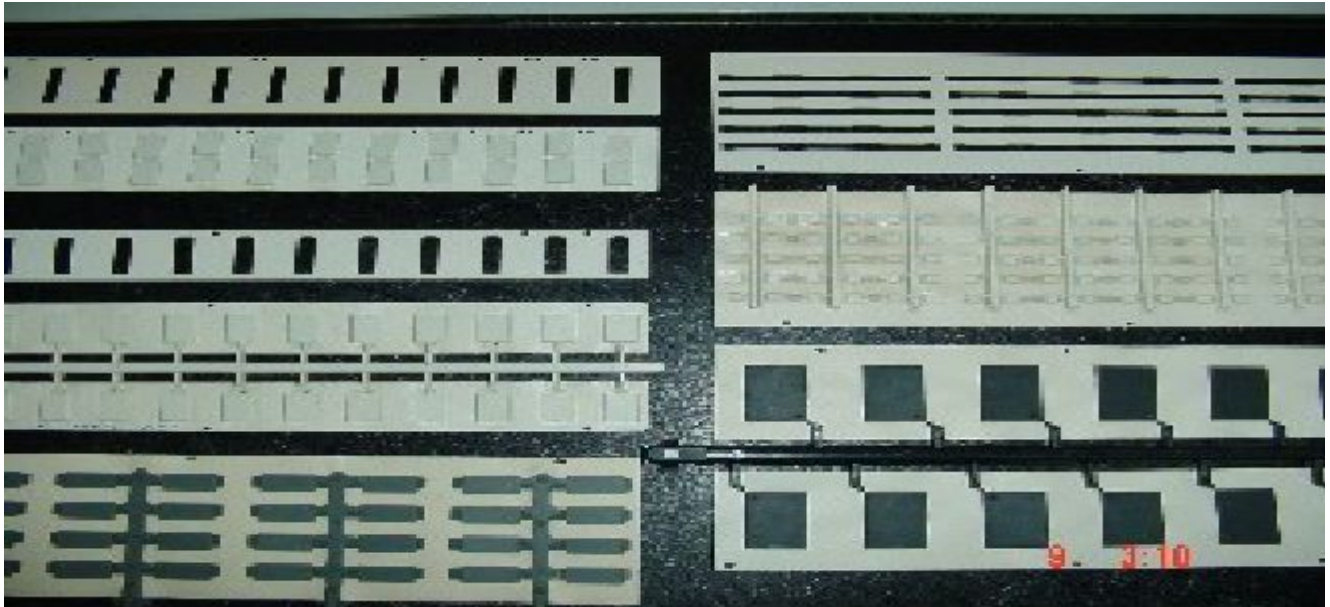
PAPERFRAME™ Samples



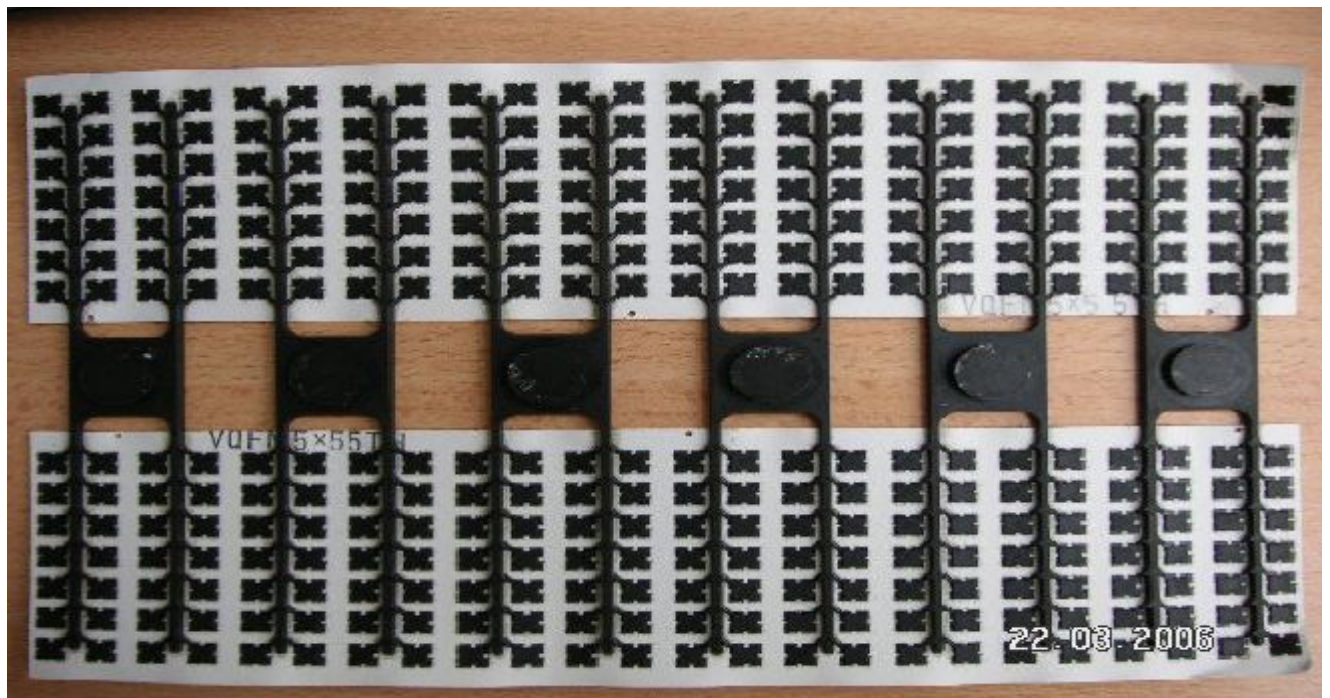


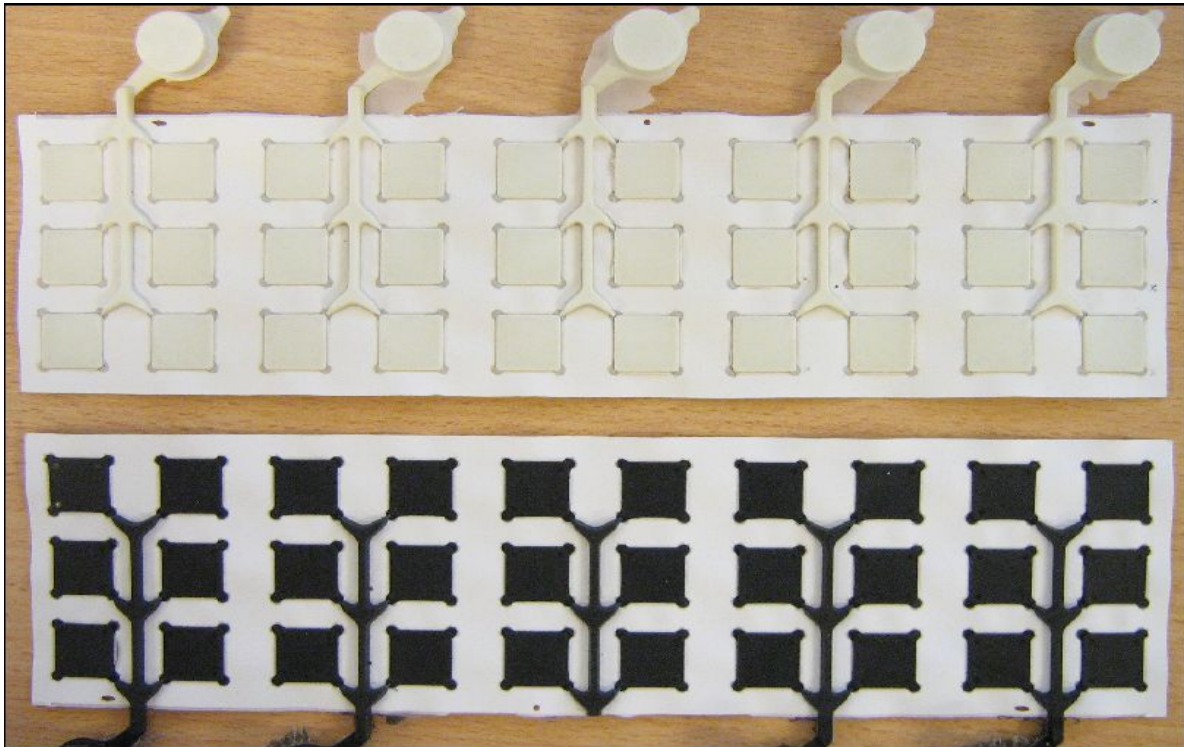


Molded PAPERFRAME™

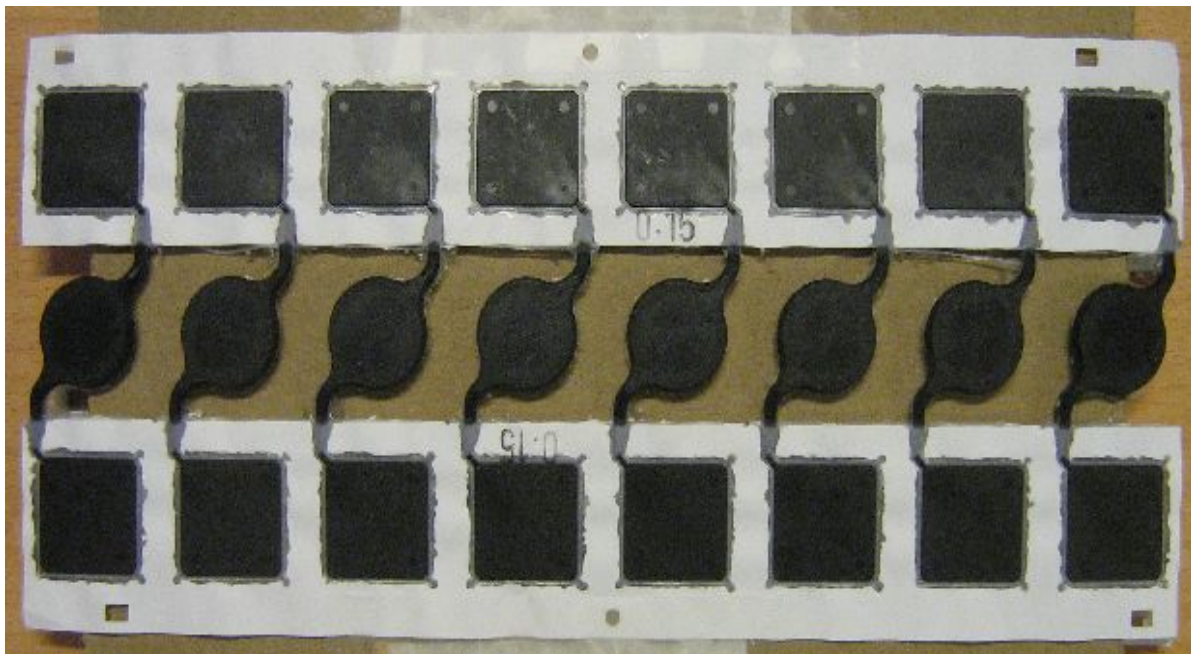


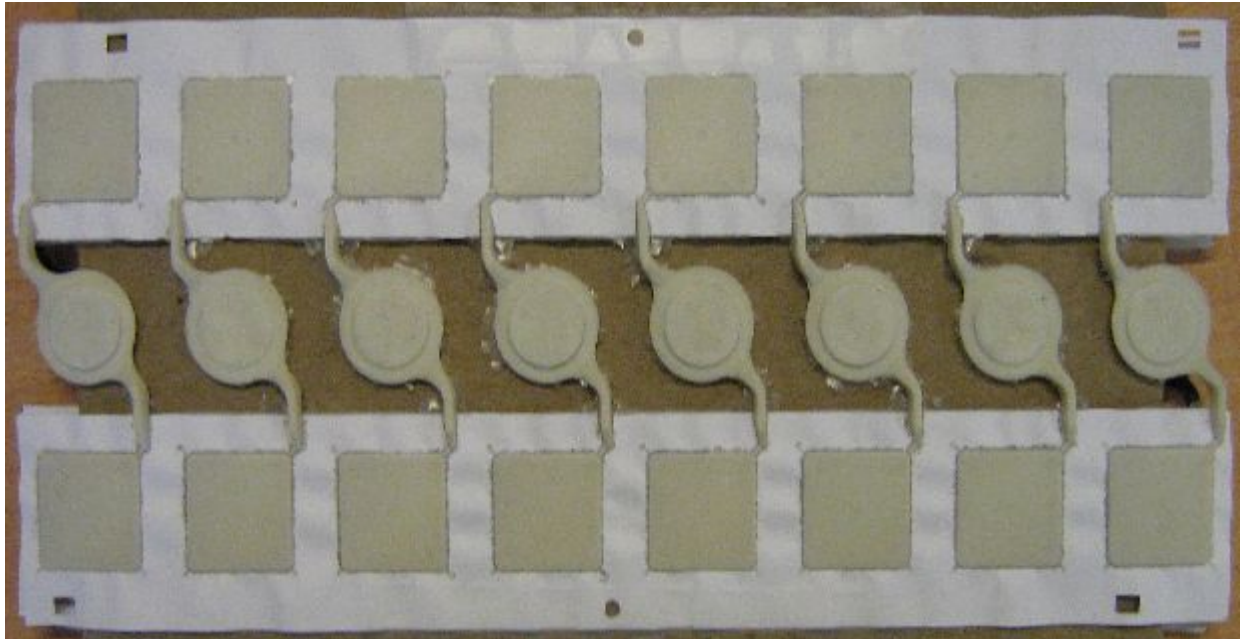
Melamine Mold Compound & Molding Compound



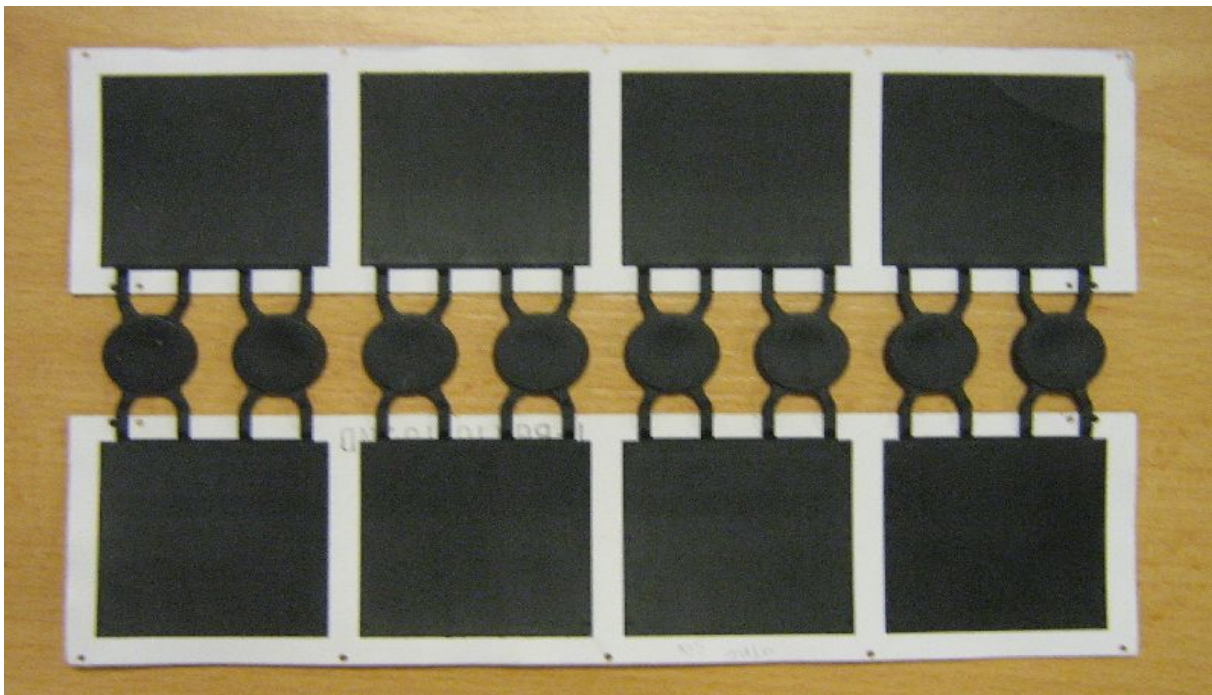


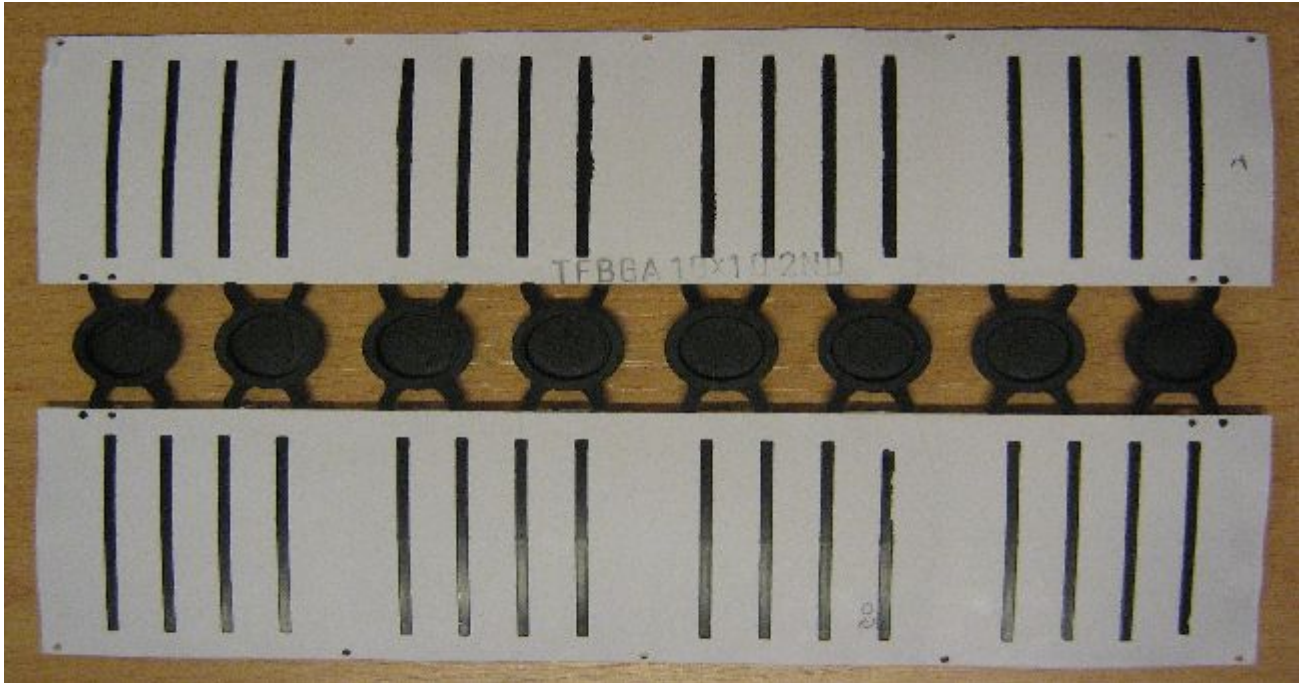
Melamine Cleaning Compound & Conditioning Compound





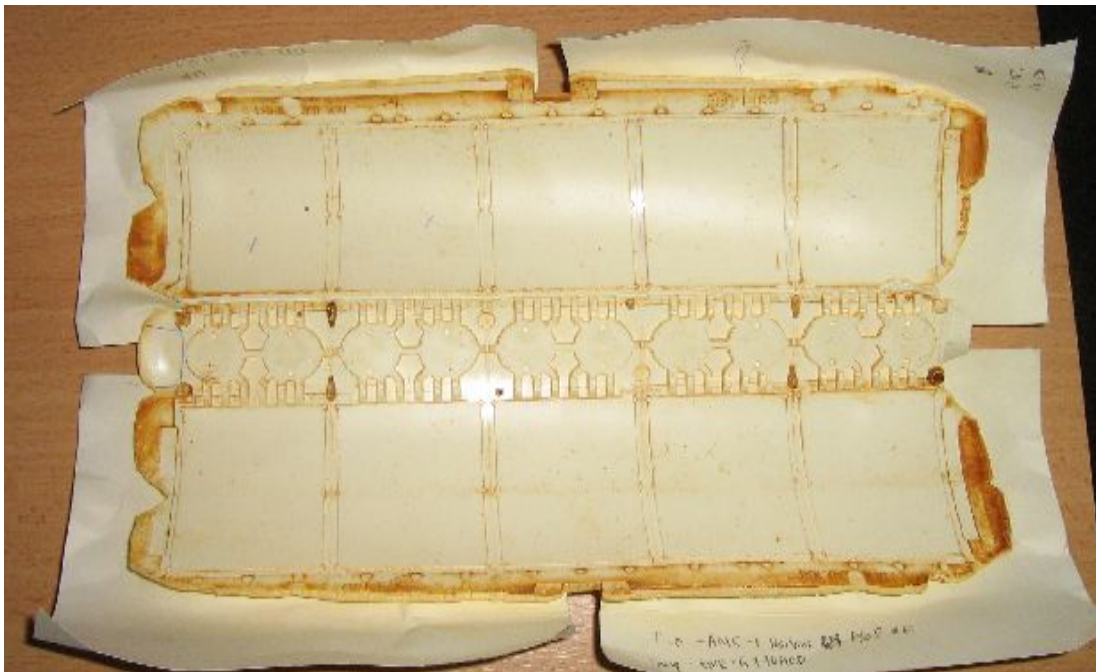
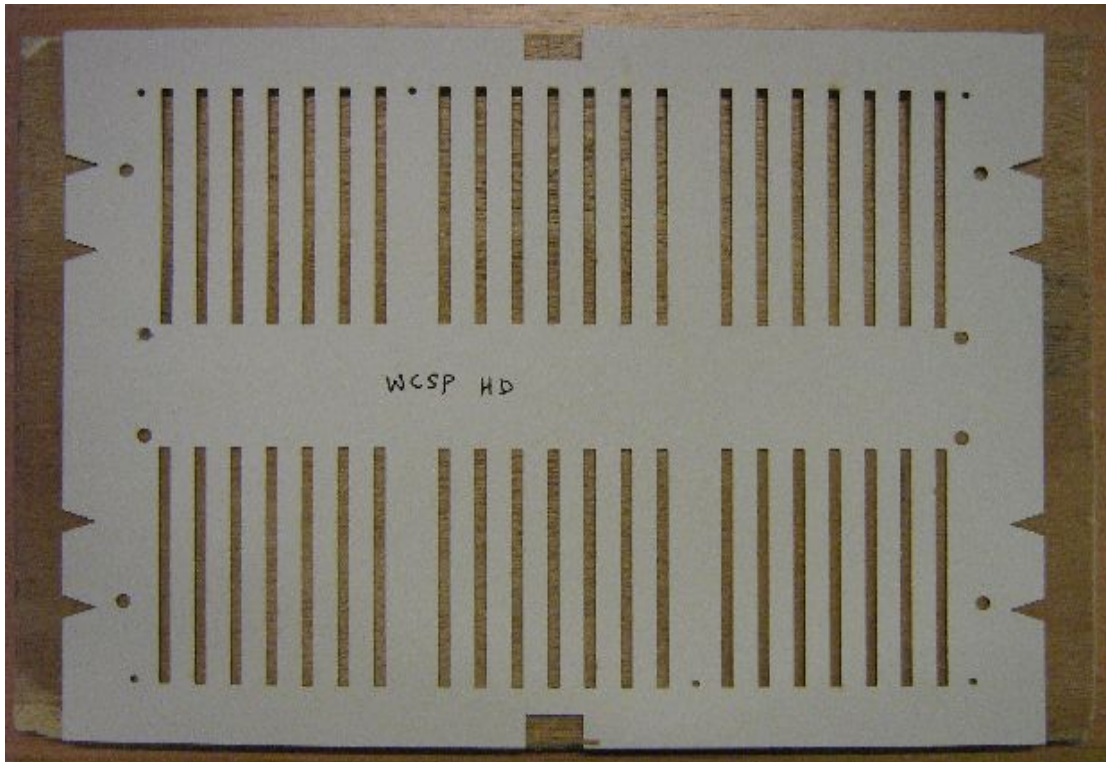
Melamine Cleaning Compound & Conditioning Compound





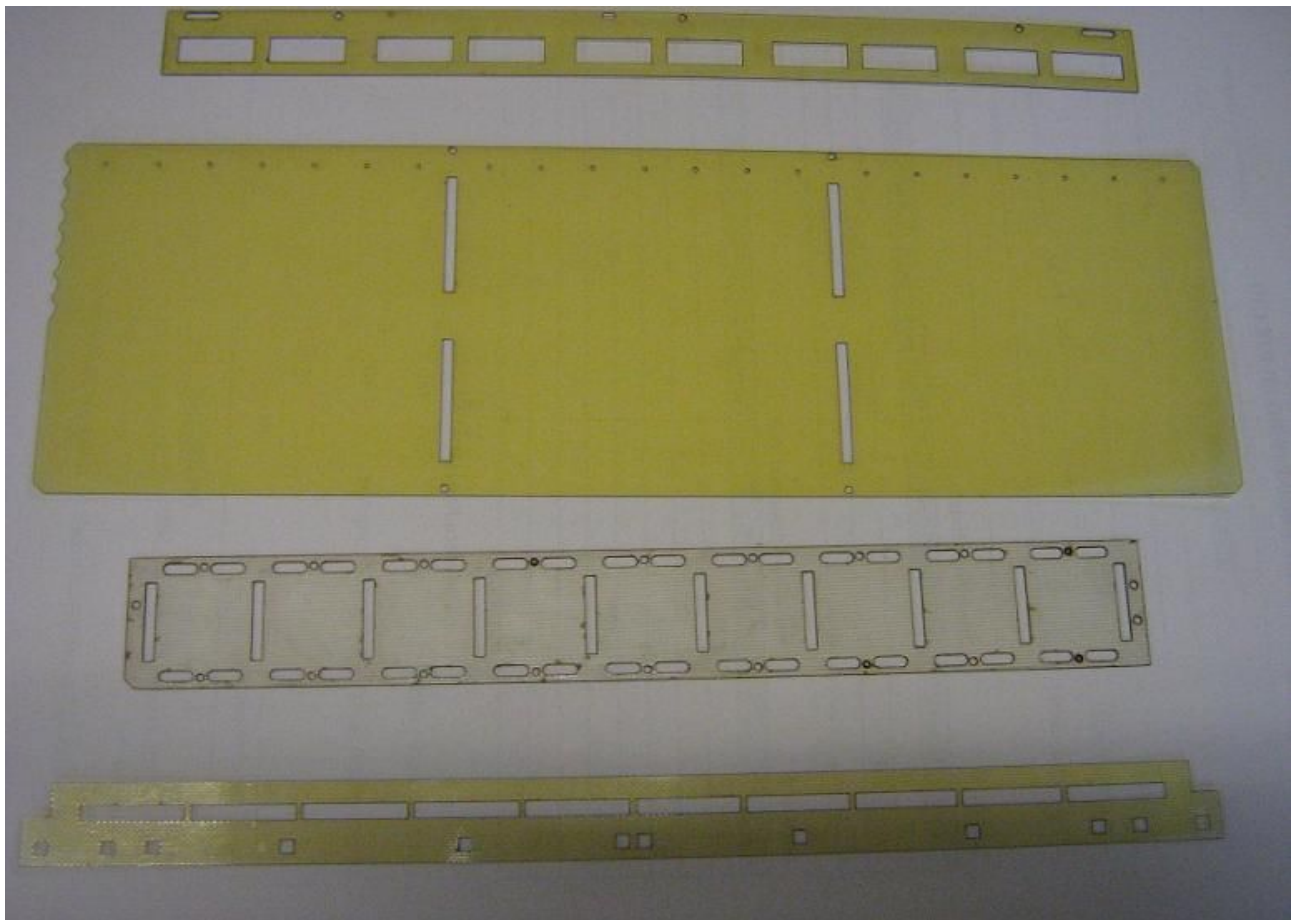
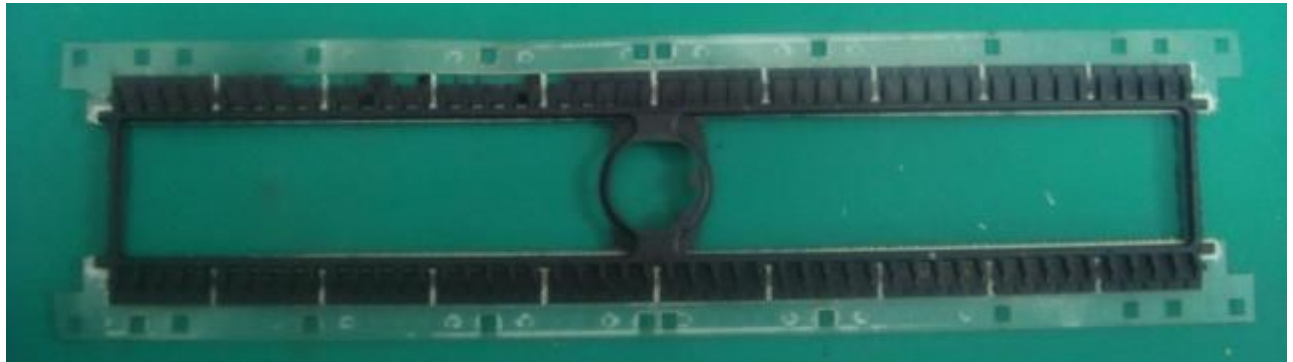
Melamine Cleaning Compound & Conditioning Compound

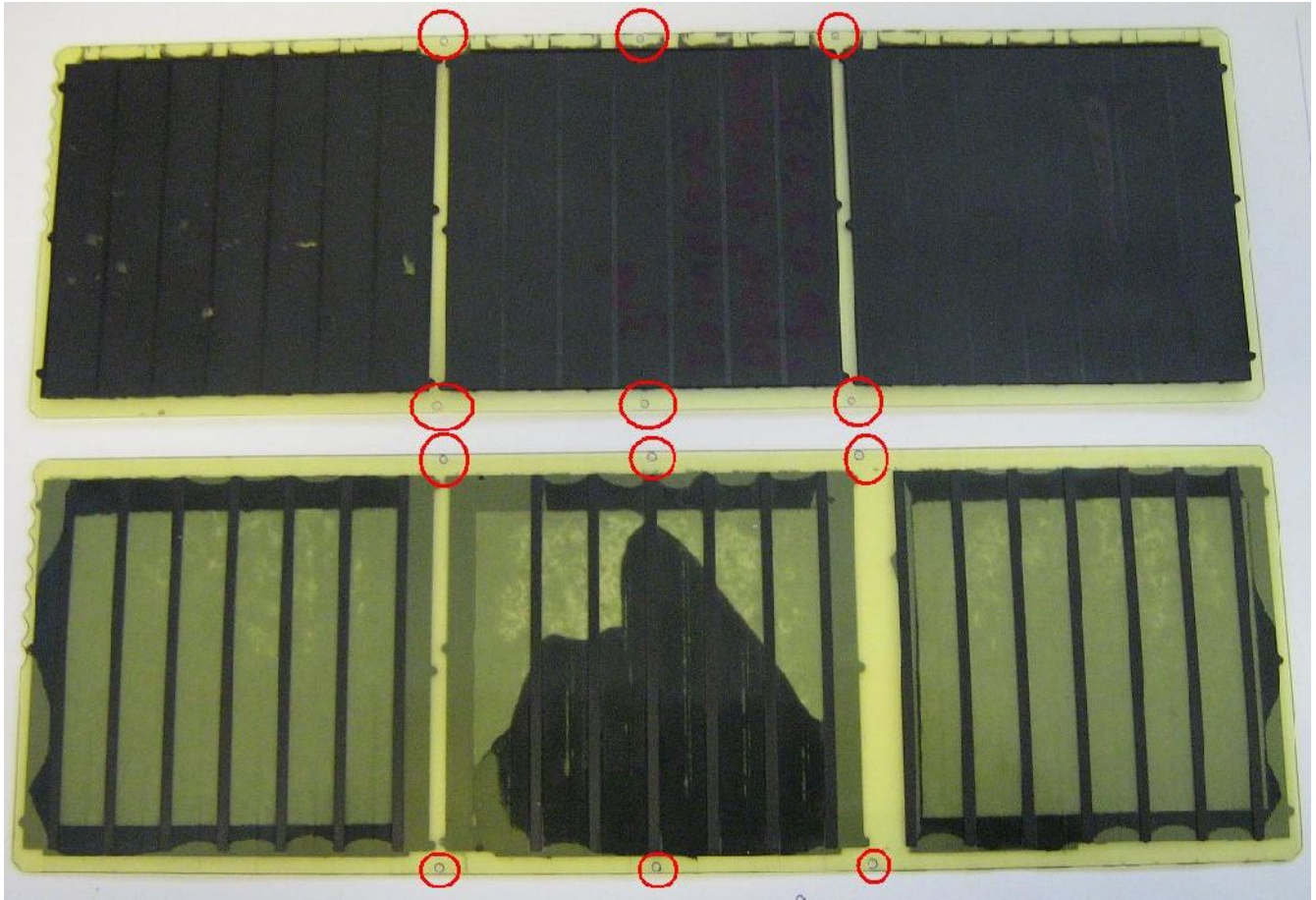
PAPERFRAME™ Application with Rubber Cleaning Sheet





BOARDFRAME™ Samples





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